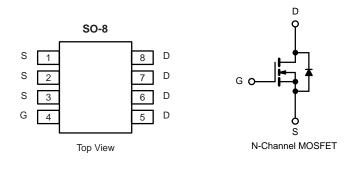


N-Channel 150 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
150	0.080 at V _{GS} = 10 V	5.4	23 nC			
150	0.085 at V _{GS} = 8 V	4.5	23110			



FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Extremely Low Q_{gd} for Switching Losses
- 100 % Rg Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



Available

Parameter Drain-Source Voltage Gate-Source Voltage		Symbol	Limit	Unit	
		V _{DS}	150		
		V _{GS}	± 20		
	T _C = 25 °C		5.4		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		5.1		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	5.0 ^{b, c}		
	T _A = 70 °C		4.5 ^{b, c}		
Pulsed Drain Current		I _{DM}	22	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		4.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.6 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	20	mJ	
	T _C = 25 °C		5.9		
Maximum Dowar Dissinction	T _C = 70 °C		3.8	w	
Maximum Power Dissipation	$T_A = 25 \text{ °C}$	P _D	3.1 ^{b, c}	VV	
	T _A = 70 °C		2 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
	Symbol	Typical	Maximum	Unit			
t ≤ 10 s	R _{thJA}	33	40	°C/W			
Steady State	R _{thJF}	17	21	- C/W			
	t ≤ 10 s	Symbol t ≤ 10 s R _{thJA}	Symbol Typical t ≤ 10 s R _{thJA} 33	Symbol Typical Maximum t ≤ 10 s R _{thJA} 33 40			

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	150			V	
V _{DS} Temperature Coefficient	AVaa/T.			172		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 10		mv/-C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zaro Gato Voltago Drain Current	1	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30			А	
Drain-Source On-State Resistance ^a	P	V _{GS} = 10 V, I _D = 5 A		0.080	0.090		
Dialit-Source Off-State Resistance	R _{DS(on)}	$V_{GS} = 8 V, I_{D} = 5 A$		0.085	0.095	Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 5 A		23		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1735		pF	
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		160			
Reverse Transfer Capacitance	C _{rss}			37			
Total Gate Charge	0	$V_{DS} = 75$ V, $V_{GS} = 10$ V, $I_{D} = 5$ A		28.5	43	43 35 nC	
	Qg			23	35		
Gate-Source Charge	Q _{gs}	V_{DS} = 75 V, V_{GS} = 8 V, I_{D} = 5 A		8			
Gate-Drain Charge	Q _{gd}			6.5			
Gate Resistance	R _g	f = 1 MHz		0.85	1.3	Ω	
Turn-on Delay Time	t _{d(on)}			14	21		
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong \text{5}$ A, V_GEN = 10 V, R_g = 1 Ω		22	33		
Fall Time	t _f			6	10		
Turn-On Delay Time	t _{d(on)}			16	24	ns	
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 8 \text{ V}, \text{ R}_g = 1 \Omega$		20	30		
Fall Time	t _f			7	12		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			7.7	А	
Pulse Diode Forward Current ^a	I _{SM}				50		
Body Diode Voltage	V _{SD}	I _S = 2.6 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			63	95	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5 A, dl/dt = 100 A/μs, T _J = 25 °C		110	165	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ u/ul} = 100 \text{ A/µs}, I_J = 25 ^{\circ}\text{C}$		49			
Reverse Recovery Rise Time	t _b			14	1	ns	

emi

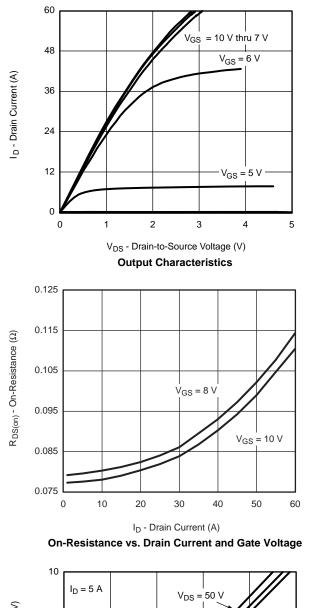
Notes:

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

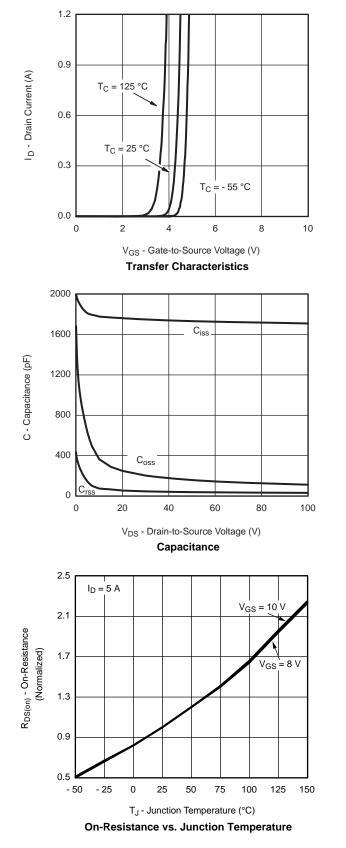
a. Guaranteed by design, not subject to production testing.

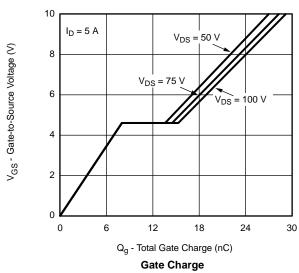
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







T_J = 125 °C

8

10

6

0.1

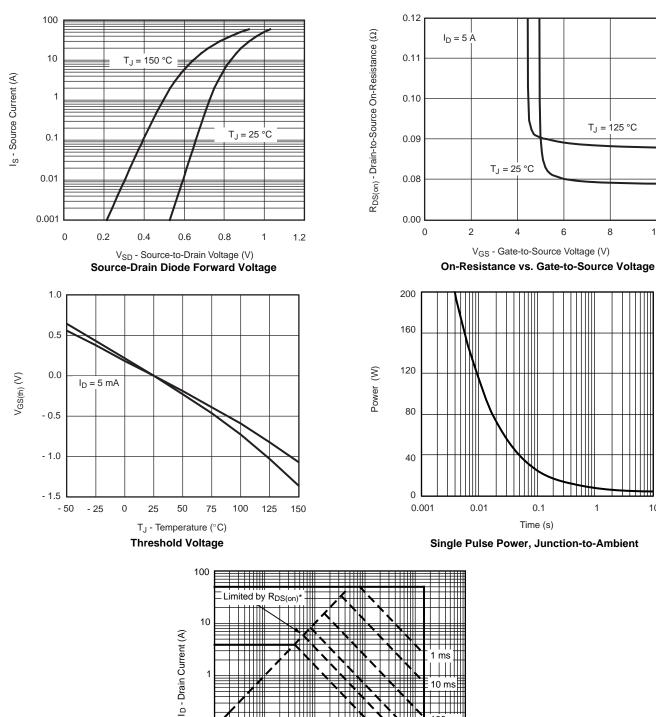
100 m

1000

100

1

10



0.1

0.01 0.01 T_A = 25 °C

Single Pulse

0.1

ТП

1

V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified Safe Operating Area, Junction-to-Ambient

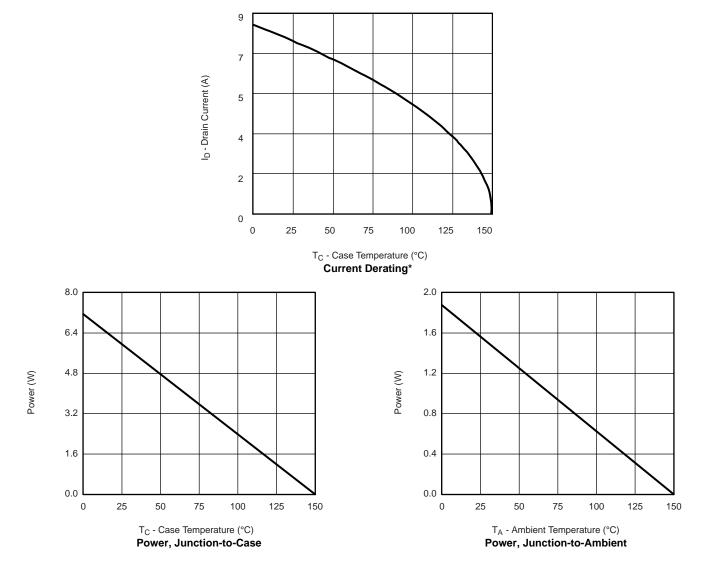
10

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





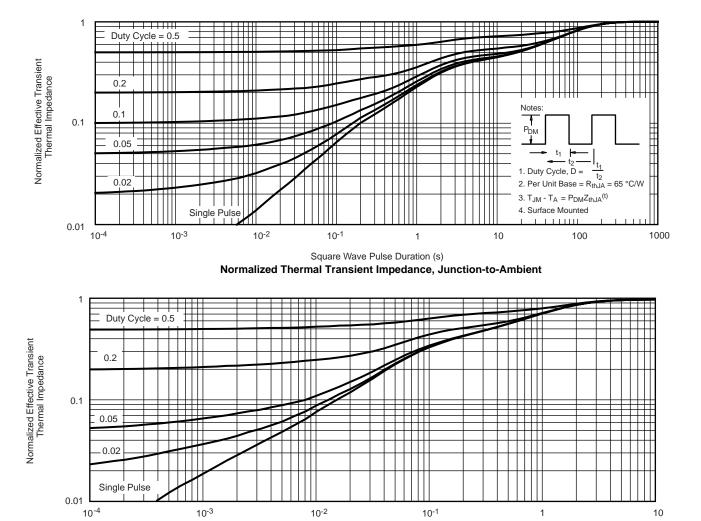
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

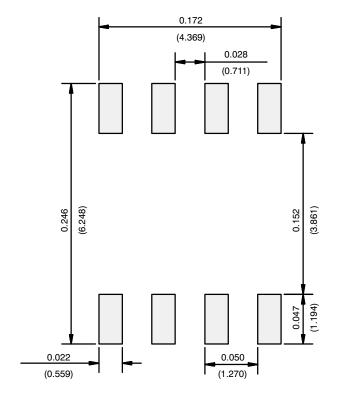




	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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